

JN-AN-1235

JN517x Power consumption

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Application Note

Document information

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Abstract	Application note for JN517x platform design.



Revision history

Rev	Date	Description
0.x	2013	Previous release in Jennic templated. Updated for JN516x devices and removed JN5139/48 information
0.9	June 2016	Update for JN517x products
1.0	October 2016	Web release



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1. Introduction

This application note describes how to calculate the power required by an NXP JN517x wireless microcontroller running an IEEE 802.15.4-based application. The formulae necessary to calculate the time required to complete common 802.15.4 network operations are presented in conjunction with the electrical current consumed by the JN517x devices during these operations. Additionally, timings and current consumption information are provided for specific tasks. An example is included that describes how the information presented can be used to determine the battery capacity requirements of an application.

2. IEEE 802.15.4 network operations

The timings of all 802.15.4 operations are based on one fundamental piece of information, the symbol rate. When operating in the 2.4 GHz band, the symbol rate is defined as 62500 symbols per second. Each symbol comprises four bits of information and, therefore, the over-air data rate is 250 kbps. Below are the formulae required to calculate the time taken to perform common 802.15.4 network operations, based on this data rate.

2.1 Energy Detection (ED) scan

This is dependent on the number of channels to be scanned and the time for which each one is scanned, both of which are selected by the user.

NumberOfChannelsScanned = 1 to 16

ScanDuration = 0 to 14

ED Scan Period (ms) = $[960 \times (2^{\text{ScanDuration}} + 1) / 62.5] \times \text{NumberOfChannelsScanned}$

2.2 Data transmission

The maximum size of a data frame is 127 Bytes at Physical Layer, 9 to 25 Bytes form the MAC layer header. The size of the MAC layer header is dependent on the addressing mode used; see the table below for details.

Addressing mode*	MAC header size (Bytes)
No source or destination address (only PAN ID included)	9
16-bit source and destination addresses	13
64-bit source and destination addresses	25

* Further addressing mode combinations are available; see the IEEE 802.15.4 Standard for details.

The remaining 102 to 114 Bytes can be used for the transmission of data. The total time taken to transmit a single data frame can be calculated as follows:

PayloadSize (Bytes) = 1 to 114

MACHeaderSize (Bytes) = 9 to 25

PhyHeaderSize (Bytes) = 6

$$\text{HeaderSize (Bytes)} = \text{MACHeaderSize} + \text{PhyHeaderSize} = 15 \text{ to } 31$$

$$\text{Data Frame Transmission Period (ms)} = (\text{HeaderSize} + \text{PayloadSize}) \times 8 / 250$$

2.3 Beacon frame transmission

The maximum size of a beacon frame is 127 Bytes. This comprises a Physical layer header, a MAC layer header, beacon overhead and the beacon payload. The Physical layer header size is fixed at 6 Bytes. The size of the MAC layer header is dependent on the addressing mode used; see the table below for details.

Addressing mode	MAC header size (Bytes)
16-bit short address	11
64-bit address	17

The Beacon overhead depends on the number of GTSs used and the number of pending address fields. The beacon payload can take up the remaining Bytes and is available for the transmission of application-specific data.

$$\text{PHYHeaderSize} = 6 \text{ Bytes}$$

$$\text{MACHeaderSize} = 11 \text{ or } 17 \text{ Bytes}$$

$$\text{BeaconOverhead} = 3 \text{ to } 52 \text{ Bytes}$$

$$\text{BeaconPayload} =$$

$$0 \text{ to } (127 - \text{PHYHeaderSize} - \text{MACHeaderSize} - \text{BeaconOverhead}) \text{ Bytes}$$

$$\text{Beacon Frame Transmission Period (ms)} =$$

$$(\text{PHYHeaderSize} + \text{MACHeaderSize} + \text{BeaconOverhead} + \text{BeaconPayload}) \times 8 / 250$$

2.4 CSMA/CA channel access

Access to the radio channel is gained using the CSMA/CA algorithm. Before a data frame is transmitted, a Clear Channel Assessment (CCA) is performed to determine if the channel is currently in use. The CCA takes 8 symbol periods (0.128 ms) to complete. The time at which the CCA is performed and how frequently it is repeated (if the channel is found to be busy) are determined by the type of CSMA/CA algorithm used.

If regular beacons are not used then data is transmitted using unslotted CSMA/CA. This algorithm is based on back-off periods, where one back-off period is equal to 20 symbol periods. Two variables are used by the algorithm:

- *NB* is the number of times the algorithm has been required to back off while attempting the current transmission; this is initialised to zero.
- *BE* is the back-off exponent and is related to how many back-off periods a device will wait before attempting to assess the channel – the maximum number of back-off periods is given by $(2^{BE} - 1)$. *BE* is initialised to *macMinBE* (in the range 0 to 3) and has a default value of 3.

The unslotted CSMA/CA algorithm works as follows:

1. NB is set to 0, BE is set to $macMinBE$
2. Delay implemented for a random period in the range 0 to $(2^{BE} - 1)$ back-off periods
3. CCA is performed
4. If the channel is idle then data is transmitted, otherwise algorithm continues to Step 5
5. NB is set to $NB + 1$, BE is set to $\min(BE + 1, aMaxBE)$
6. If NB is greater than $macMaxCSMABackoffs$ then the transmission has failed, otherwise algorithm returns to Step 2.

The time between requesting that a data frame is transmitted and it actually being transmitted is therefore dependent on the back-off period and the result of the CCA. The time taken to complete a single back-off period can be calculated as follows:

$$\text{BackoffPeriod (ms)} = (2^{BE} - 1) \times 20 / 62.5$$

(NB: with 62500 symbols per second, 1 symbol period equal to $1/62500 \text{ s} = 16 \mu\text{s}$)

2.5 Data reception

The time taken to receive a data frame is exactly the same as the time taken to transmit it. However, it should be noted that the receiver must be switched on at some point before the data frame is expected to arrive. How long before depends on the type of network being used (beacon or non-beacon enabled) and how the application uses the network. An examination of this is beyond the scope of this document.

3. JN517x current consumption

Remark: Unless otherwise explicitly specified the supply and V_{DD} in this data sheet refers to inputs V_{DDA} and V_{DDD} , also by default the delays and power numbers are quoted with respect to the supply from V_{DDA} and V_{DDD} . For the SMPS input supply ($V_{DD(SMPS)}$), the input current and start-up time are specified separately and should be added to the specs of V_{DD} .

DC current

This section contains information regarding the current consumption of the JN517x while performing various operations. All quoted currents are average values. Extraction done from JN517x datasheet.

Table 1. JN517x current consumption summary

$V_{DD} = 2\text{ V to }3.6\text{ V}$; $T_{amb} = -40\text{ }^{\circ}\text{C to }+125\text{ }^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
I_{DD}	supply current	CPU in doze mode; analog and digital	[1]				
		with radio in receive mode; maximum input level at 10 dBm; high-performance mode	-	14.8	-	mA	
		with radio in receive mode; maximum input level at -2 dBm; low-power mode	-	12.7	-	mA	
		with radio in transmit mode 10 dBm	[2]	22.5	-	mA	
		with radio in transmit mode 8.5 dBm	[2]	19.6	-	mA	
		with radio in transmit mode 3 dBm	-	14	-	mA	
		without radio	-	2	-	mA	
		CPU processing at:	[3]				
		32 MHz	-	2.62	-	mA	
		16 MHz	-	1.54	-	mA	
		8 MHz	-	0.89	-	mA	
		4 MHz	-	0.49	-	mA	
2 MHz	-	0.28	-	mA			
1 MHz	-	0.15	-	mA			
$I_{DD(ADC)}$	ADC supply current		[4][5]	390	-	μA	
$I_{DD(comp)}$	comparator supply current	operating mode	[5]				
		low-power mode	-	70	-	μA	
			-	0.62	-	μA	
$I_{DD(UART)}$	UART supply current	per UART	[5]	60	-	μA	
$I_{DD(tmr)}$	timer supply current	per timer	[5]	54	-	μA	
$I_{DD(sintf)}$	serial interface supply current	SPI-bus supply current	[5]	40	-	μA	

[1] Doze mode = CPU is not clocked.

[2] To reach the maximum TX power, 2.8 V is the minimum.

[3] Digital consumption only. When in CPU doze, the current related to CPU speed is not consumed. This value should be added to the CPU in doze mode supply current value.

[4] Temperature sensor and battery measurements require ADC.

[5] These numbers should be added to I_{DD} if the feature is being used.

Table 2. Sleep mode JN517x

$V_{DD} = 2\text{ V to }3.6\text{ V}$; $T_{amb} = -40\text{ °C to }+125\text{ °C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{DD(I/O)}$	I/O supply current	analog and digital supply current; with IO and 1 × RC oscillator timer wake-up; $T_{amb} = 25\text{ °C}$	[1] -	0.61	-	μA
$I_{DD(xtal)}$	crystal oscillator supply current	for 32 kHz internal RC oscillator	[1]			
		HIGH current	-	0.76	-	μA
		LOW current	-	0.40	-	μA
$I_{ret(RAM)}$	RAM retention current	$T_{amb} = 25\text{ °C}$	[2] -	0.6	-	μA
$I_{DD(comp)}$	comparator supply current	low-power mode	[1][2][3] -	0.62	-	μA

[1] Waiting on IO event.

[2] RAM and comparator supply currents should be added to $I_{DD(I/O)}$ if the feature is being used.

[3] Reduced response time.

Table 3. Deep-sleep mode JN517x

$V_{DD} = 2\text{ V to }3.6\text{ V}$; $T_{amb} = -40\text{ °C to }+125\text{ °C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{DD}	supply current	analog and digital supply current; deep-sleep mode; measured at 25 °C	[1] -	100	-	nA

[1] Waiting on chip RESET or IO event.

4. JN517x wake-up timings

This section contains information about the time taken by the JN517x to perform operations that are not related to the 802.15.4 protocol.

Table 4. Wake-up timing

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t _{startup}	start-up time	CPU start up time; time for crystal to stabilize ready to run CPU; reached oscillator amplitude threshold. Default bias current	-	0.87	-	ms
		radio start-up time; time for crystal to stabilize ready for radio activity	-	1.10	-	ms
		from reset RESET_N pin, BOR or SVM	-	310	-	μs
t _{wake}	wake-up time	from deep sleep mode or sleep mode without RAM retention	-	300	-	μs
		from sleep mode with RAM retention	-	210	-	μs
		from CPU Doze mode	-	7	-	μs

5. Battery capacity calculation – example for JN517x

The following example illustrates how to calculate the battery capacity required by a device in a non-beacon enabled star network that continuously performs the following actions:

1. Wakes from sleep
2. Reads data from a sensor connected to the two-wire serial interface
3. Performs a Clear Channel Assessment (CCA)
4. Transmits a data frame containing a payload of 64 Bytes
5. Sleeps (without holding the memory contents) for 10 min before repeating Step 1

The durations and electrical currents corresponding to the above phases of device operation are determined below.

Waking from Sleep

If the contents of RAM have not been held, the time taken to wake from sleep mode can be calculated by adding the oscillator start-time to the application bootloader time (the bootloader initialises the .bss and .data RAM segments). Note that the JN517x devices start up using a fast RC oscillator and begin executing bootloader code at 26 MHz. After a further (870-300) μs, the faster 32 MHz crystal has stabilized and a glitch-less switchover occurs. The application code should wait until the crystal is stable for radio transmission, which occurs a further 230 μs later (i.e. 1.1 ms from reset/wake event)

$$\text{Time to wake from sleep} = (1.1 - 0.3) = \mathbf{0.8 \text{ ms}}$$

While the bootloader is initializing the C-runtime environment, the wireless transceiver will not be operating and therefore the current drawn is **3.54 mA** (CPU clock rate of 16 MHz – default value).

Reading data from sensors

It is assumed that it takes **1 ms** to read data from the sensor attached to the two-wire serial interface. During this time, the current drawn by the JN517x is **3.6 mA**. No account is taken of the current drawn by the sensor.

Performing CCA

Before a data frame can be transmitted, the CSMA/CA algorithm is used to check that the channel is not being used. The time taken to execute the CSMA/CA algorithm in a non-beacon enabled network (assuming that the channel is found to be clear after the CCA and that the random back-off period is 2) can be calculated as follows:

$$\text{BackoffPeriod (ms)} = (2^2 - 1) \times 20 / 62.5 = \mathbf{0.96 \text{ ms}}$$

$$\text{CCA Period (ms)} = \mathbf{0.128 \text{ ms}}$$

During the back-off period, the application is running and the transceiver is on although it is not transmitting and receiving. The current drawn during this period is **3.72 mA**. During a CCA, the radio receiver is on and therefore the current drawn is **14.24 mA**.

Transmitting data

Assuming that no source and destination data is included, the time taken to transmit a data frame can be calculated as follows:

$$\text{Data Frame Transmission Period (ms)} = (\text{HeaderSize} + \text{PayloadSize}) \times 8 / 250$$

$$\text{Data Frame Transmission Period (ms)} = (15 + 64) \times 8 / 250 = \mathbf{2.528 \text{ ms}}$$

The current drawn during this period is **19.6 mA**, the default transmitting current at 8.5 dBm.

While sleeping

The current drawn during the (approximately) **10-minute** sleep period is **0.61 µA** (Sleep mode with I/O and RC oscillator timer wake-up).

Using the above time and current data, it is possible to calculate that the average current required by the application is approximately **0.712 µA** (see below for detailed calculation).

The device should therefore be capable of operating for over 36 years when powered by a CR2032 225-mAh button-cell.


The average current drawn by this application can be calculated by adding the electrical charge consumed during each phase and dividing by the total cycle time (10 minutes).

Phase	Current (mA) x Time (ms)	Charge (µC)
Wake from sleep	3.54 mA x 0.8 ms	2.83
Read sensors	3.6 mA x 1 ms	3.6

Phase	Current (mA) x Time (ms)	Charge (µC)
CCA back-off	3.72 mA x 0.96 ms	3.57
CCA	14.24 mA x 0.128 ms	1.82
Transmit data	19.6 mA x 2.528 ms	49.54
Sleep	0.00061 mA x 600000 ms	366
	Total	427

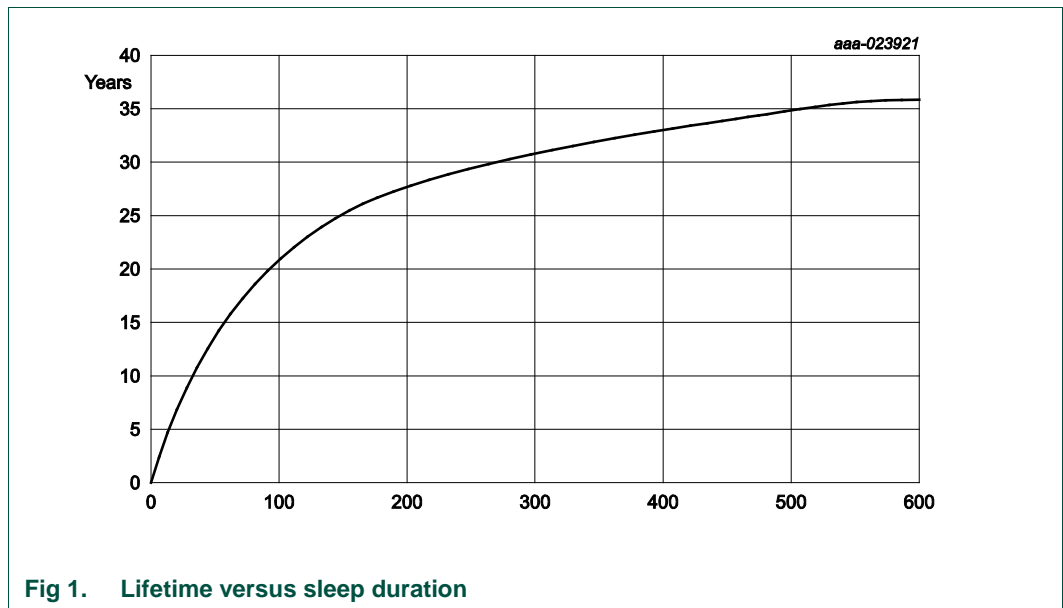
Therefore, 427 µC of charge is consumed over a total cycle time of 600 s (10 minutes):

$$\text{Average Current} = \text{Total Charge Consumed} / \text{Time} = 427 / 600 = \mathbf{0.712 \mu A}$$



Note: This figure does not take into account the current drawn by the sensor or the self-discharge of the battery.

If the calculations are repeated for a range of sleep durations, the following graph of lifetime versus sleep duration is produced.



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